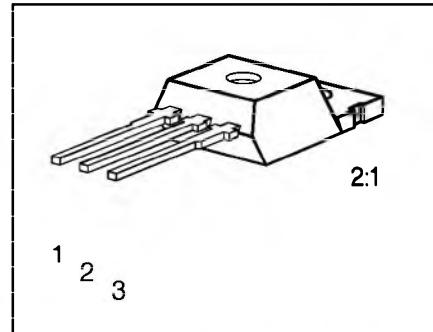


- P channel
- Enhancement mode
- Temperature sensor with thyristor characteristic
- The drain pin is electrically shorted to the tab



Pin	1	2	3
	G	D	S

Refer to circuit design hints (see chapter Technical Information)

Type	$V_{DS}$	$I_D$	$R_{DS(on)}$	Package	Ordering Code
BTS 100	- 50 V	- 8 A	0.3 Ω	TO-220AB	C67078-A5007-A2

### Maximum Ratings

Parameter	Symbol	Values	Unit
Drain-source voltage	$V_{DS}$	- 50	V
Drain-gate voltage, $R_{GS} = 20 \text{ k}\Omega$	$V_{DGn}$	- 50	
Gate-source voltage	$V_{GS}$	± 20	
Continuous drain current, $T_C = 30^\circ\text{C}$	$I_D$	- 8.0	A
ISO drain current $T_C = 85^\circ\text{C}$ , $V_{GS} = 10 \text{ V}$ , $V_{DS} = 0.5 \text{ V}$	$I_{D-ISO}$	- 1.5	
Pulsed drain current, $T_C = 25^\circ\text{C}$	$I_{D \text{ puls}}$	- 32	
Short circuit current, $T_j = - 55 \dots + 150^\circ\text{C}$	$I_{SC}$	- 25	
Short circuit dissipation, $T_j = - 55 \dots + 150^\circ\text{C}$	$P_{SCmax}$	500	W
Power dissipation	$P_{tot}$	40	
Operating and storage temperature range	$T_j, T_{stg}$	- 55 ... + 150	°C
DIN humidity category, DIN 40 040	-	E	-
IEC climatic category, DIN IEC 68-1	-	55/150/56	
Thermal resistance			K/W
Chip-case	$R_{th JC}$	≤ 3.1	
Chip-ambient	$R_{th JA}$	≤ 75	

**Electrical Characteristics**

at  $T_j = 25^\circ\text{C}$ , unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**Static Characteristics**

Drain-source breakdown voltage $V_{GS} = 0, I_D = -0.25 \text{ mA}$	$V_{(BR)DSS}$	- 50	-	-	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = -1 \text{ mA}$	$V_{GS(\text{th})}$	- 2.5	- 3.0	- 3.5	
Zero gate voltage drain current $V_{GS} = 0 \text{ V}, V_{DS} = -50 \text{ V}$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	$I_{DSS}$	-	- 1 - 100	- 10 - 300	$\mu\text{A}$
Gate-source leakage current $V_{GS} = -20 \text{ V}, V_{DS} = 0$ $T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	$I_{GSS}$	-	- 10 - 2	- 100 - 4	$\text{nA}$ $\mu\text{A}$
Drain-source on-state resistance $V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$	$R_{DS(\text{on})}$	-	0.25	0.3	$\Omega$

**Dynamic Characteristics**

Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(\text{on})\text{max}}, I_D = -5 \text{ A}$	$g_{fs}$	1.5	2.3	4.0	S
Input capacitance $V_{GS} = 0, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$	$C_{iss}$	-	900	1200	pF
Output capacitance $V_{GS} = 0, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$	$C_{oss}$	-	350	550	
Reverse transfer capacitance $V_{GS} = 0, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$	$C_{rss}$	-	130	230	
Turn-on time $t_{\text{on}}$ , ( $t_{\text{on}} = t_{d(\text{on})} + t_r$ ) $V_{CC} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -2.9 \text{ A}, R_{GS} = 50 \Omega$	$t_{d(\text{on})}$ $t_r$	- -	20 60	30 95	ns
Turn-off time $t_{\text{off}}$ , ( $t_{\text{off}} = t_{d(\text{off})} + t_f$ ) $V_{CC} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -2.9 \text{ A}, R_{GS} = 50 \Omega$	$t_{d(\text{off})}$ $t_f$	- -	70 55	90 75	

**Electrical Characteristics (cont'd)**  
at  $T_j = 25^\circ\text{C}$ , unless otherwise specified.

<b>Parameter</b>	<b>Symbol</b>	<b>Values</b>			<b>Unit</b>
		<b>min.</b>	<b>typ.</b>	<b>max.</b>	

### Reverse Diode

Continous source current	$I_S$	-	-	- 8.0	A
Pulsed source current	$I_{SM}$	-	-	- 32	
Diode forward on-voltage $I_F = - 16 \text{ A}, V_{GS} = 0$	$V_{SD}$	-	- 1.0	- 1.7	V
Reverse recovery time $I_F = I_S, di_F/dt = - 100 \text{ A}/\mu\text{s}, V_R = - 30 \text{ V}$	$t_{rr}$	-	90	-	ns
Reverse recovery charge $I_F = I_S, di_F/dt = - 100 \text{ A}/\mu\text{s}, V_R = - 30 \text{ V}$	$Q_{rr}$	-	0.23	-	$\mu\text{C}$

### Temperature Sensor

Forward voltage $I_{TS(on)} = - 10 \text{ mA}, T_j = - 55 \dots + 150^\circ\text{C}$ Sensor override, $t_p \leq 100 \mu\text{s}$ $T_j = - 55 \dots + 160^\circ\text{C}$	$V_{TS(on)}$	-	- 1.4	- 1.5	V
Forward current $T_j = - 55 \dots + 150^\circ\text{C}$ Sensor override, $t_p \leq 100 \mu\text{s}$ $T_j = - 55 \dots + 160^\circ\text{C}$	$I_{TS(on)}$	-	-	- 10	mA
Holding current, $V_{TS(off)} = - 5 \text{ V}, T_j = 25^\circ\text{C}$ $T_j = 150^\circ\text{C}$	$I_H$	- 0.05 - 0.05	- 0.1 - 0.2	- 0.5 - 0.3	
Switching temperature $V_{TS} = - 5 \text{ V}$	$T_{TS(on)}$	150	-	-	$^\circ\text{C}$
Turn-off time $V_{TS} = - 5 \text{ V}, I_{TS(on)} = - 2 \text{ mA}$	$t_{off}$	0.5	-	2.5	$\mu\text{s}$

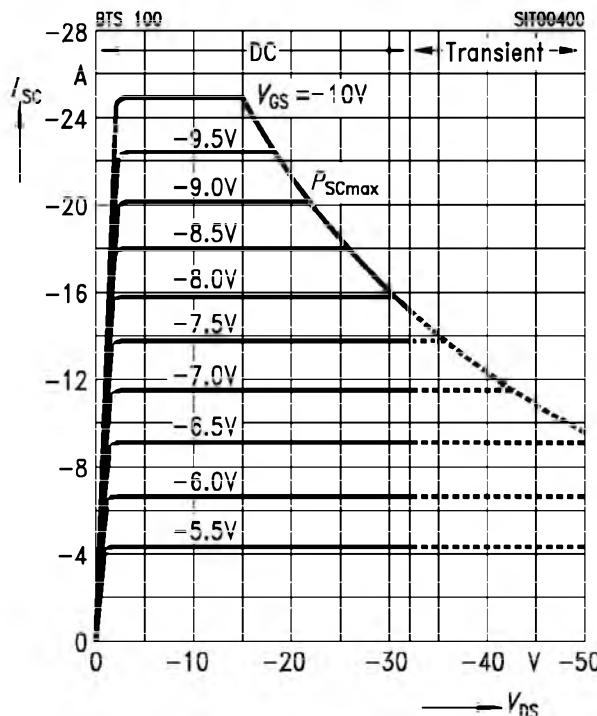
**Examples for short-circuit protection**

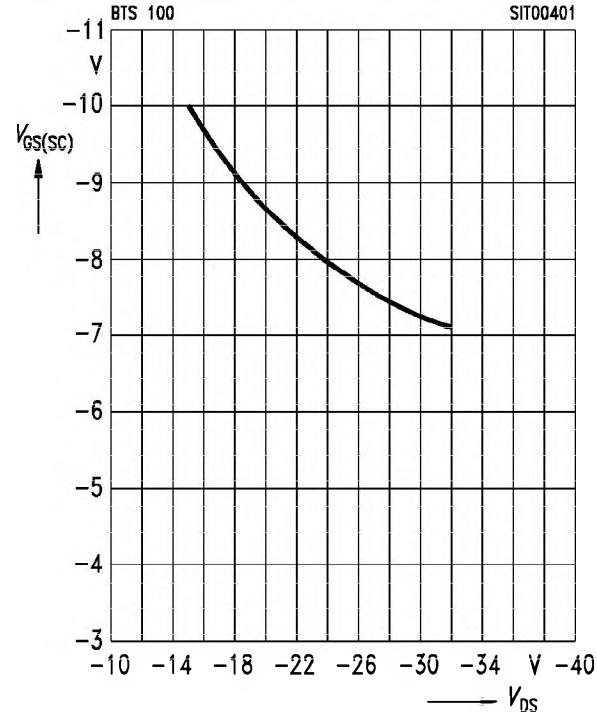
at  $T_j = -55 \dots +150^\circ\text{C}$ , unless otherwise specified.

Parameter	Symbol	Example		Unit
		1	2	
Drain-source voltage	$V_{DS}$	-15	-30	-
Gate-source voltage	$V_{GS}$	-10	-8.2	-
Short-circuit current	$I_{SC}$	$\leq -25$	$\leq -16$	-
Short-circuit dissipation	$P_{SC}$	375	480	-
Response time $T_j = 25^\circ\text{C}$ , before short circuit	$t_{SC(\text{off})}$	55	55	ms

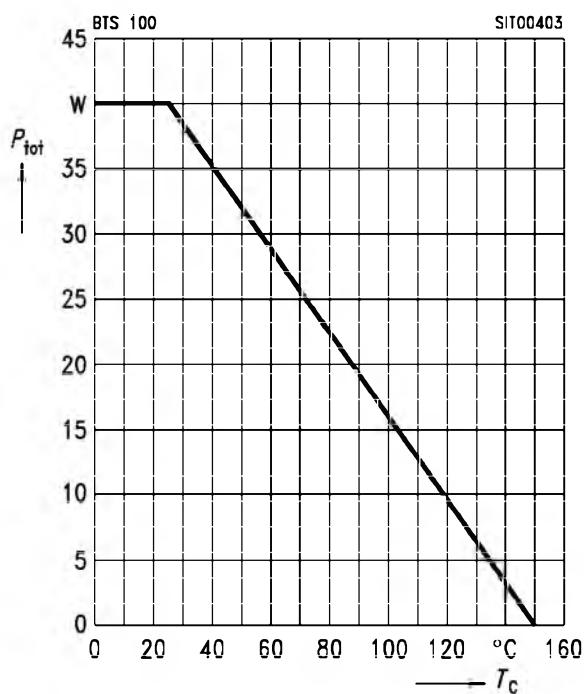
**Short-circuit protection  $I_{SC} = f(V_{DS})$** 

Parameter:  $V_{GS}$ 

Diagram to determine  $I_{SC}$  for  $T_j = -55 \dots +150^\circ\text{C}$ 

**Max. gate voltage  $V_{GS(SC)} = f(V_{DS})$** 

Parameter:  $T_j = -55 \dots +150^\circ\text{C}$ 


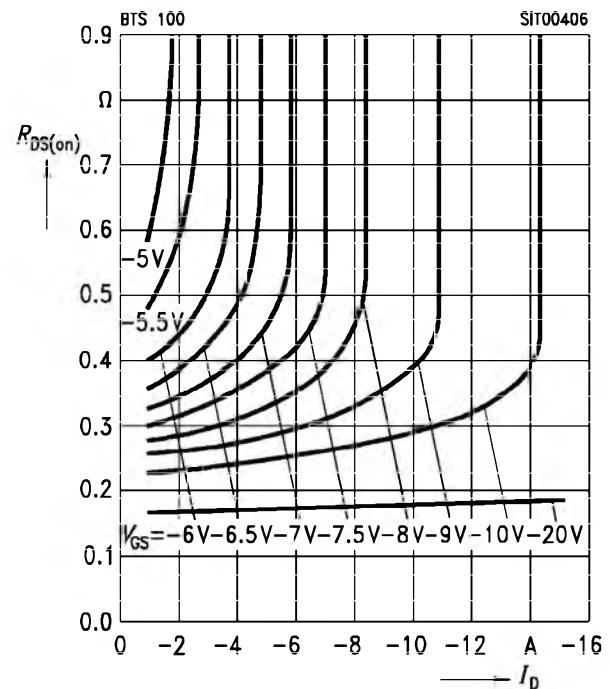
**Max. power dissipation**  $P_{\text{tot}} = f(T_c)$



**Typ. drain-source on-state resistance**

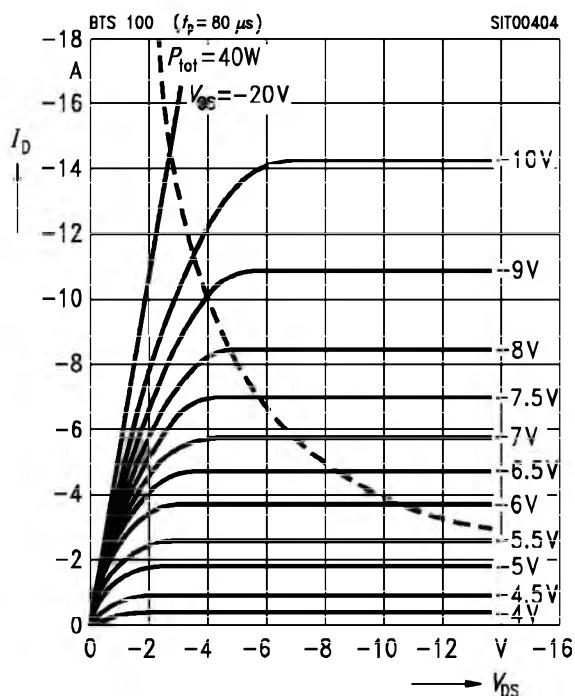
$R_{DS(\text{on})} = f(I_D)$

Parameter:  $V_{GS}$



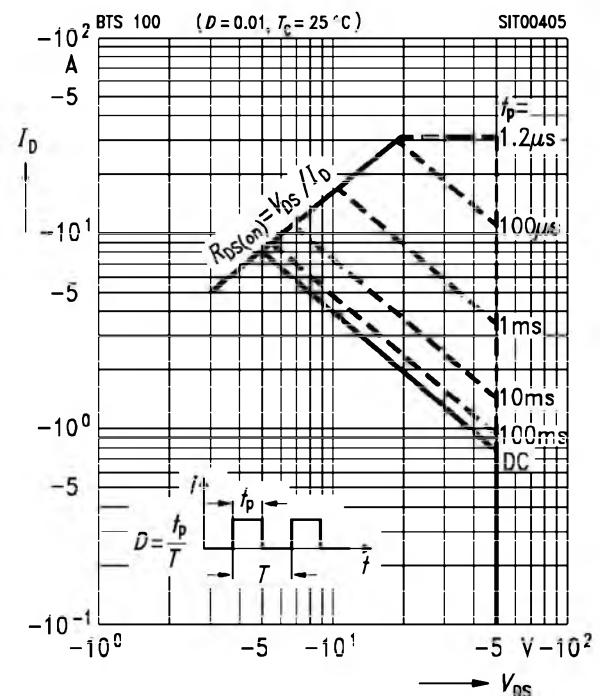
**Typical output characteristics**  $I_D = f(V_{DS})$

Parameter:  $t_p = 80 \mu\text{s}$



**Safe operating area**  $I_D = f(V_{DS})$

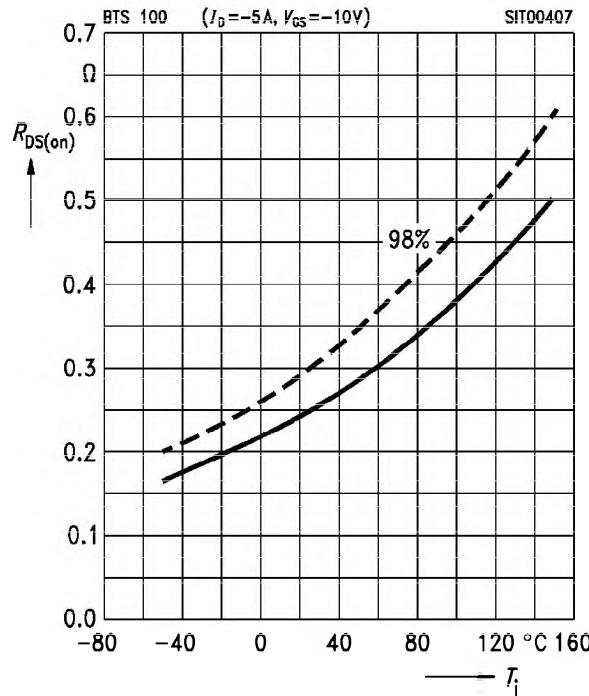
Parameter:  $D = 0.01$ ,  $T_c = 25^\circ\text{C}$



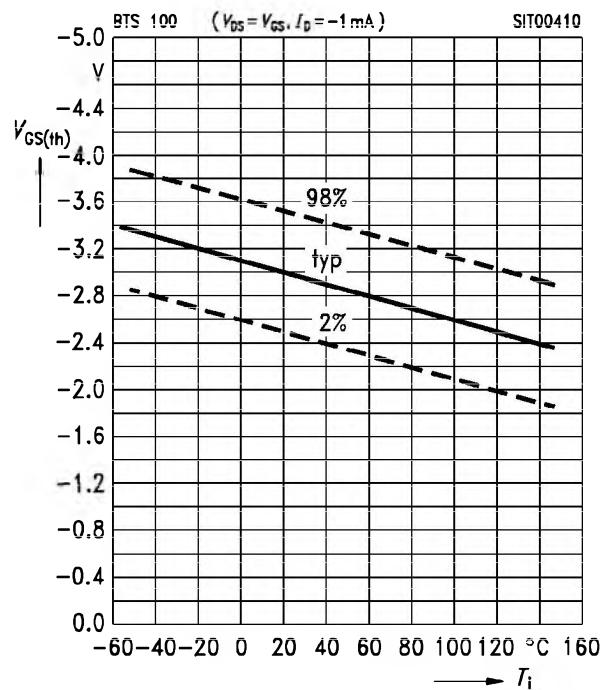
**Drain-source on-state resistance**

$$R_{DS(on)} = f(T_j)$$

Parameter:  $I_D = -5 \text{ A}$ ,  $V_{GS} = -10 \text{ V}$

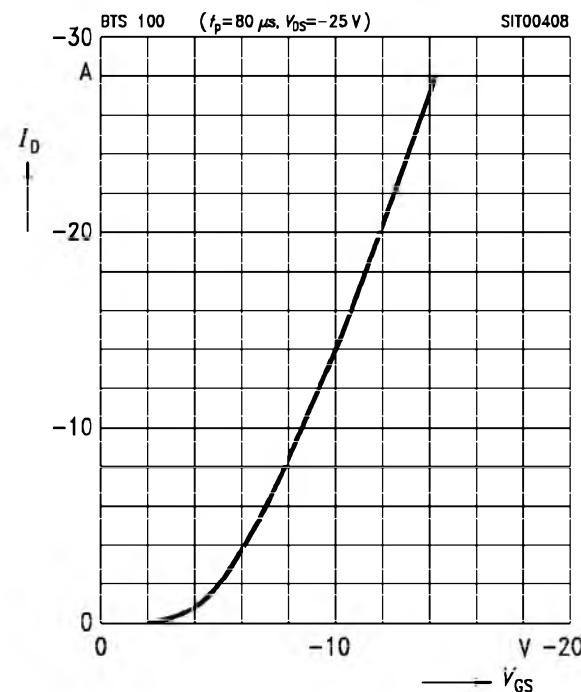
**Gate threshold voltage  $V_{GS(th)} = f(T_j)$** 

Parameter:  $V_{DS} = V_{GS}$ ,  $I_D = -1 \text{ mA}$

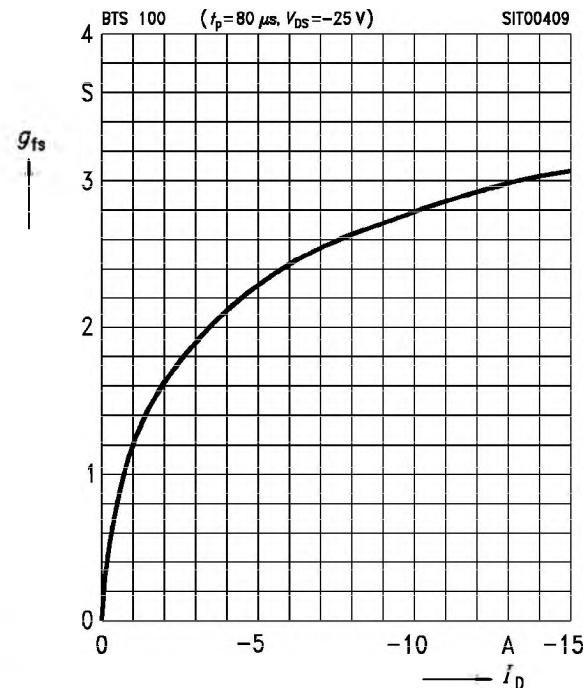
**Typ. transfer characteristic**

$$I_D = f(V_{GS})$$

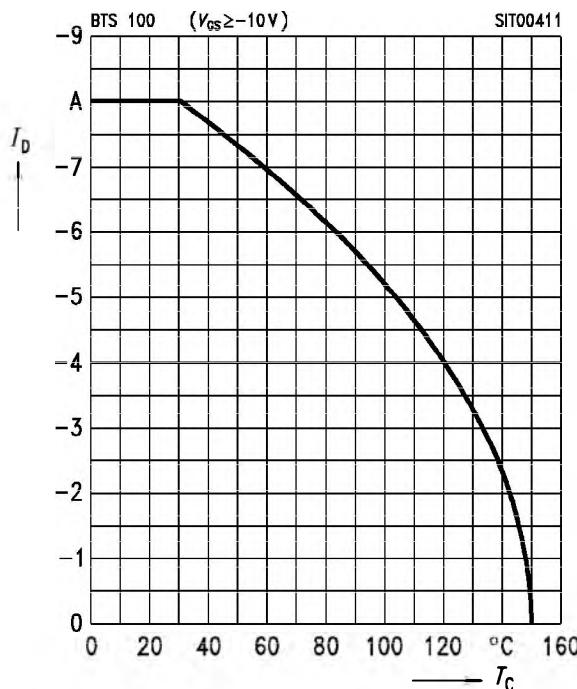
Parameter:  $t_p = 80 \mu\text{s}$ ,  $V_{DS} = -25 \text{ V}$

**Typ. transconductance  $g_{fs} = f(I_D)$** 

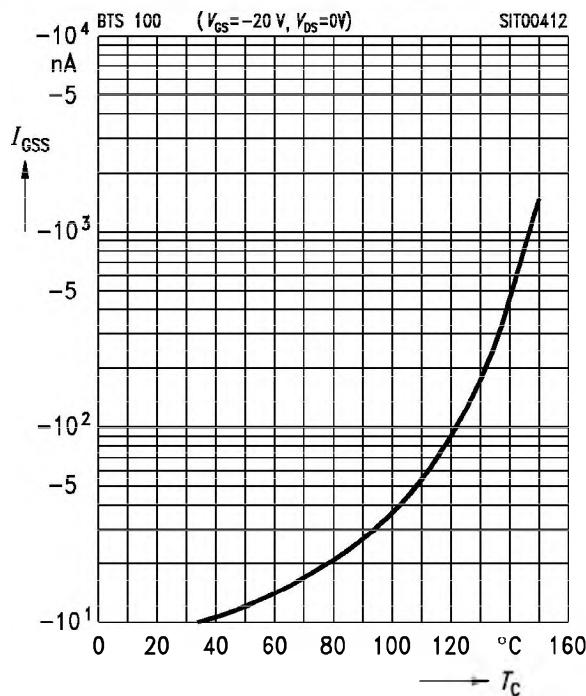
Parameter:  $t_p = 80 \mu\text{s}$ ,  $V_{DS} = -25 \text{ V}$



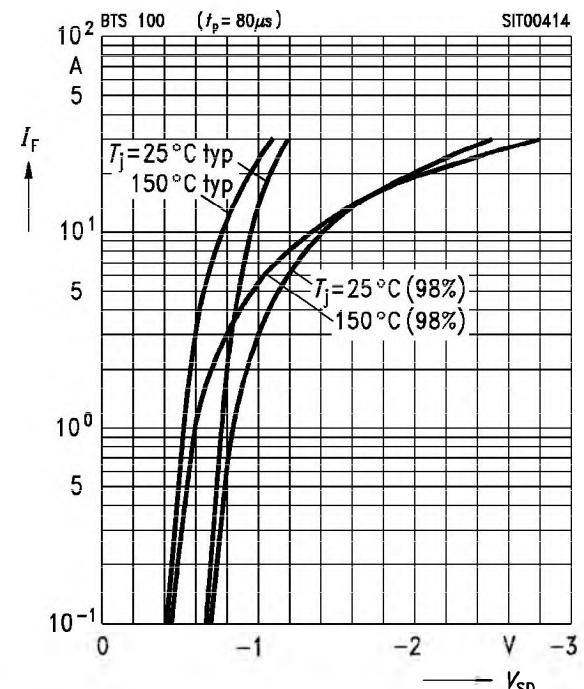
**Continuous drain current  $I_D = f(T_C)$**   
Parameter:  $V_{GS} \geq -10$  V



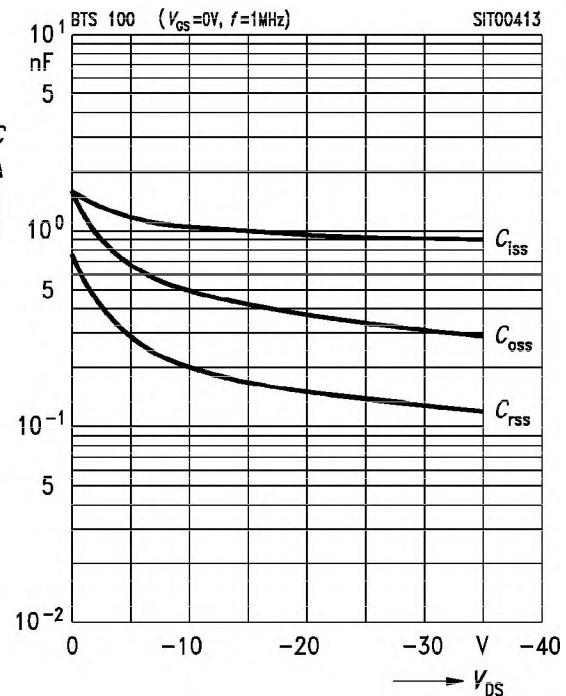
**Typ. gate-source leakage current**  
 $I_{GSS} = f(T_C)$   
Parameter:  $V_{GS} = -20$  V,  $V_{DS} = 0$



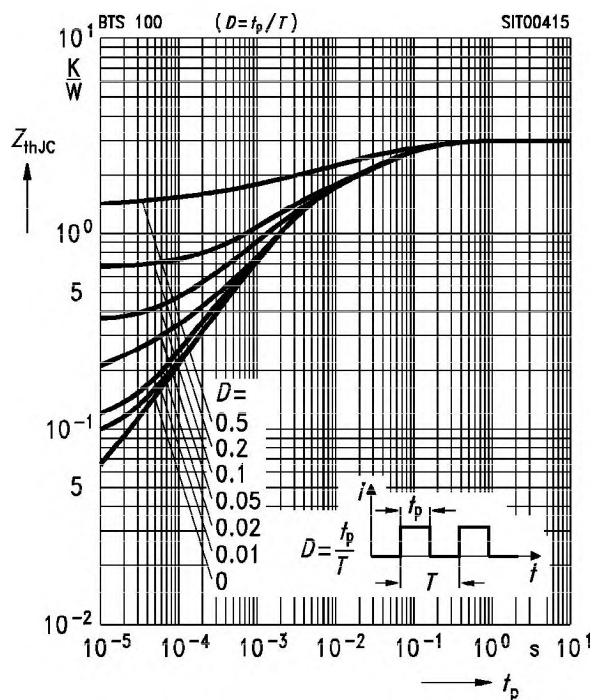
**Forward characteristics of reverse diode**  
 $I_F = f(V_{SD})$   
Parameter:  $T_j, t_p = 80 \mu\text{s}$



**Typ. capacitances  $C = f(V_{DS})$**   
Parameter:  $V_{GS} = 0$ ,  $f = 1$  MHz

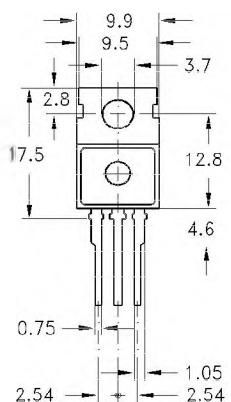


**Transient thermal impedance**  $Z_{\text{thJC}} = f(t_p)$   
Parameter:  $D = t_p/T$



**TO 220 AB**  
Standard

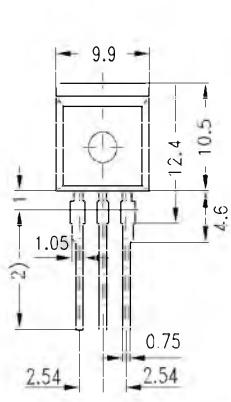
**Ordering Code**  
C67078-A5007-A2



GPT05155

**TO 220 AB**  
Option E 3046

**Ordering Code**  
C67078-A5007-A4

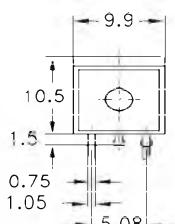


GPT05338

1) shear and punch direction no burrs this surface  
2) dip tinning

**TO 220 AB**  
SMD version E3045

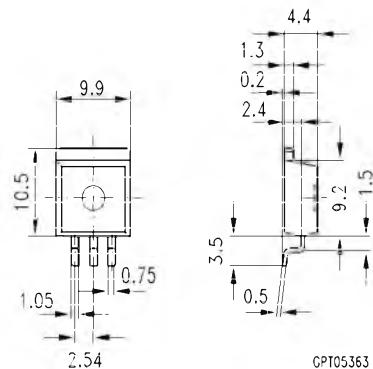
**Ordering Code**  
C67078-A5007-A7



GPD05164

**TO 220 AB**  
SMD version E3044

**Ordering Code**  
C67078-A5007-A9



GPT05363